

Special Issue

Advanced III-Nitride Technologies for Power and RF Applications: Recent Breakthroughs and Future Prospects

Message from the Guest Editor

Wide- and ultrawide-bandgap III-nitride semiconductors (GaN, Al_xGa_{1-x}N, AlN) exhibit remarkable properties that position them as pivotal materials in the production of next-generation power and RF electronic devices. The focus of this Special Issue is to provide a comprehensive overview of the most recent advances in the realm of III-nitride-based semiconductors, encompassing innovative device architecture, carrier transport, and emerging trends. The scope of this Special Issue extends across a diverse array of subjects. These include but are not limited to the following areas:

- Vertical and lateral III-nitride based unipolar and bipolar devices for efficient power electronics and/or high frequency operation.
- Carrier transport: electron and hole gases, modeling, and simulation.
- Contact and gate stack engineering, novel field management designs.
- Monolithic integration of III-nitride devices in power integrated circuits.
- Reliability and thermal management of III-nitride devices.
- III-nitride devices for radiation hard electronics.

Guest Editor

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About the Journal

Message from the Editor-in-Chief

Electronics is a multidisciplinary journal designed to appeal to a diverse audience of research scientists, practitioners, and developers in academia and industry. The journal is devoted to fast publication of latest technological breakthroughs, cutting-edge developments, and timely reviews of current and emerging technologies related to the broad field of electronics. Experimental and theoretical results are published as regular peer-reviewed articles or as articles within Special Issues guestedited by leading experts in selected topics of interest.

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